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NCP4672

Dual Linear Voltage Regulators with V_{in} and V_{out} Voltage Detector

The NCP4672 is a dual linear voltage regulator with input voltage and output voltage detectors. This part is useful in systems where multiple voltages are required such as for core and I/O. The NCP4672 is very accurate at 2% over full input voltage and full load current. The NCP4672 eliminates the need for external voltage supervision due to the two built in voltage detectors. The voltage detector on the input is set to 7.0 V. The output voltage detector is for channel 1 and is set to 2.9 V. An external capacitor is used to set the duration of this reset signal. Other features include short circuit protection and thermal shutdown protection. The NCP4672 has been designed to work with a 4.7 μ F output capacitor having an ESR between 0.1 Ω and 5.0 Ω .

Features

- Accuracy: 2% at Full Voltage and Load
- Excellent Ripple Rejection: 70 dB @ 1 kHz
- Voltage Detector for Input Voltage
- Voltage Detector for Output Voltage
- Programmable Delay of Reset Signal
- Thermal Short Circuit Protection
- This is a Pb–Free Device

Typical Application

- Small Core and I/O Power
- Consumer Equipment
- Measurement Equipment
- Industrial Equipment

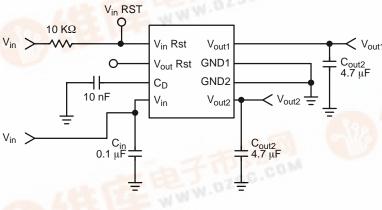




Figure 1. Typical Application Circuit



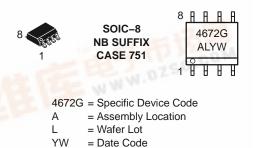
,24小时加急出货

专业PCB打样工厂

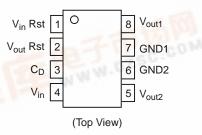
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MARKING DIAGRAM







ORDERING INFORMATION

1	Device	Package	Shipping [†]
	NCP4672DR2G	SOIC-8 (Pb-Free)	2500 Tape & Reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage	V _{inmax}	-0.3 ~ 18	V
Output Voltage	V _{out}	–0.3 to V _{in} + 0.3	V
Output Current 1 Output Current 2	l _{out1max} l _{out2max}	30 80	mA mA
Output Short Circuit Duration	-	Infinite	-
Power Dissipation and Thermal Characteristics – SOIC–8 Power Dissipation Thermal Resistance, Junction–to–Ambient Minimum Pad Size 200 mm ² Pad Size (Note 1) Thermal Resistance, Junction–to–Case	Ρ _D R _{θJA} R _{θJC}	Internally Limited 190 160 25	₩ °C/W °C/W °C/W
Operating Junction Temperature Range	T _{stg}	-40 to 125	°C
Storage Temperature Range	T _{solder}	-55 to 150	°C

1. Refer to Figure 4 for more information.

PIN DESCRIPTION

Pin Number	Symbol	Description			
1	V _{in RST}	Open-collector, active-low output of the input voltage detector with hysteresis. Threshold levels are typical 7.0 V/ 7.35 V at V _{CC} pin.			
2	V _{o RST}	Active–low output of the reset generator. Reset generator is based on sensing of the V _{out1} voltage. Sensing is with hysteresis – threshold levels are typically 2.9 V/ 2.95 V at V _{out1} . Reset is generated at rising edge of the V _{out1} and it's duration is set by external capacitor connected to C _D pin.			
3	CD	Programmable delay of the reset generator. Delay is adjusted by inserting a capacitor between $C_{\rm D}$ and GND (typically 10 ms for 10 nF capacitor).			
4	V _{CC}	Supply Voltage			
5	V _{out2}	1.8 V/ 80 mA LDO Regulator Output			
6	GND2	Ground for V _{out2} (internally connected with GND1)			
7	GND1	Ground for V _{out1} (internally connected with GND2)			
8	V _{out1}	3.5 V/30 mA LDO Regulator Output			

Recommended Conditions (T_A = 25°C, C_{in} = 0.1 μ F Ceramic, C_{out} = 4.7 μ F)

Characteristics	Symbol	Min	Тур	Max	Unit
Input Voltage	V _{in}	3.8	12	16	V
Output Current (where V _{out} remains within accuracy)	I _{out1} I _{out2}	0 0		20 70	mA

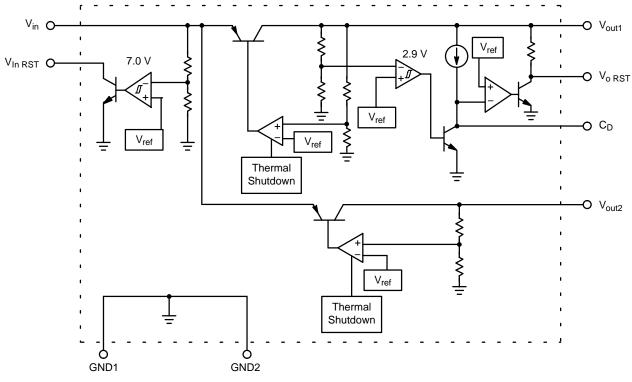


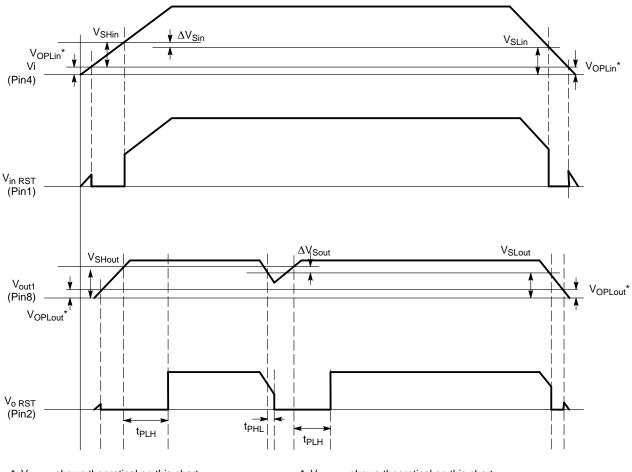
Figure 1.

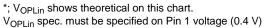
Characteristics	Symbol	Min	Тур	Max	Unit
Output Voltage V_{out1} (V _{in} = 4.5 V, I _{out1} = 20 mA) V_{out2} (V _{in} = 4.5 V, I _{out2} = 40 mA)	V _{adj}	3.43 1.764	3.5 1.8	3.57 1.836	V
Line Regulation V_{out1} (V_{in} = 4.5 V , I_{out1} = 20 mA) V_{out2} (V_{in} = 4.5 V to 10 V, I_{out2} = 40 mA)	Reg _{line}	- -	3.0 3.0	30 30	mV
Load Regulation V_{out1} (V_{in} = 4.5 V, I_{out1} = 0.1 mA to 20 mA) V_{out2} (V_{in} = 4.5 V, I_{out2} = 0.1 mA to 70 mA)	Reg _{load}		3.0 2.0	40 40	mV
Dropout Voltage V _{out1} (V _{in} = 3.3 V, I _{out1} = 20 mA)	V _{in} – V _{out1}	_	150	300	mV
Ground Pin Current ($V_{in} = 8.0 V$, $I_{out1} = I_{out2} = 0 mA$) ($V_{in} = 2.7 V$, $I_{out1} = I_{out2} = 0 mA$, Rpu = infinite)	I _{GND}		1.0 3.0	2.0 _	mA
Short Current Limit V _{out1} V _{out2}	I _{SC}	30 80	60 150		mA
Thermal Shutdown		_	165	-	°C
Temperature Coefficient V_{out1} (T _J = -30 to 85°C, V _{in} = 4.5 V, I _{out1} = 20 mA) V_{out2} (T _J = -30 to 85°C, V _{in} = 4.5 V, I _{out2} = 40 mA)	T _C		100 100		ppm/°C
	R _R		65 70		dB
Output Noise Voltage V_{out1} (V _{in} = 4.5 V, f = 20 Hz - 80 kHz, I _{out1} = 20 mA) V_{out2} (V _{in} = 4.5 V, f = 20 Hz - 80 kHz, I _{out2} = 40 mA)	V _n	- -	80 50		μV_{rms}
V _{in} Detect	•				-
Detecting Voltage L (V _{in} = H to L)	V _{SLin}	6.72	7.0	7.28	V
Detecting Voltage H (V _{in} = L to H)	V _{SHin}	_	7.35	-	V
Hysteresis Voltage (V _{in} = H to L to H)	ΔV_{Sin}	140	350	560	mV
V_{SLin} Temperature Coefficient (T _J = -30°C to +85°C)	V _{Slin} T _C	-	100	-	ppm/°C
Low-Level Output Voltage (V_{in} = 6.0 V, Vt1 = 5.0 V, Rt1 = 10 k Ω) (Note 5) Threshold Operating Voltage (V_{OPLin} = Vt1 = 1.0 V)	V _{OLin1} V _{OLin2}	-	100 -	200 0.4	mV V
V _{out} Detect					
Detecting Voltage L (V _{in} = H to L)	V _{SLout}	2.78	2.9	3.020	V
Detecting Voltage H (V _{in} = L to H)	V _{SHout}	-	2.95	-	V
Hysteresis Voltage (V _{in} = H to L to H)	ΔV_{Sout}	25	50	100	mV
V_{SLin} Temperature Coefficient (T _J = -30°C to +85°C)	V _{SLin} T _C	-	100	-	ppm/°C
Low-Level Output Voltage (V _{out1} = 2.6 V) Threshold Operating Voltage (V _{OPLout} = 0.85 V)	V _{OLout1} V _{OLout2}	-	100 -	200 0.4	mV V
Reset Delay Time (C _D = 10 nF)	t _{PLH}	5	10	15	ms
"L" Transmission Delay Time (C _D = 10 nF)	t _{PHL}	_	30	90	μs

Human Body Model 2000 V per MIL–STD–883, Method 3015 Machine Model Method 200 V.

3. The maximum package power dissipation is: $P_D = \frac{T_J(max) - T_A}{D_{T_{act}}}$

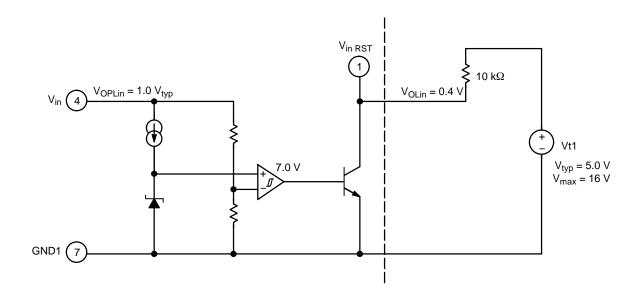
KθJA
Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
Refer to Figure 3.
Guaranteed by design.





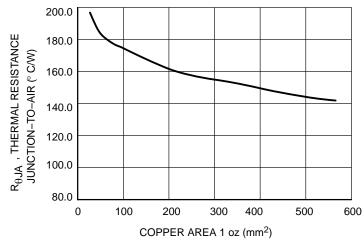
*; V_{OPLout} shows theoretical on this chart. V_{OPLout} spec. must be specified on Pin 2 voltage (0.4 V)



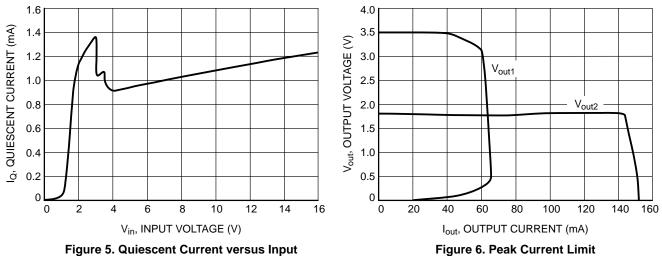












Voltage



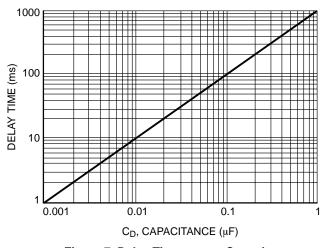
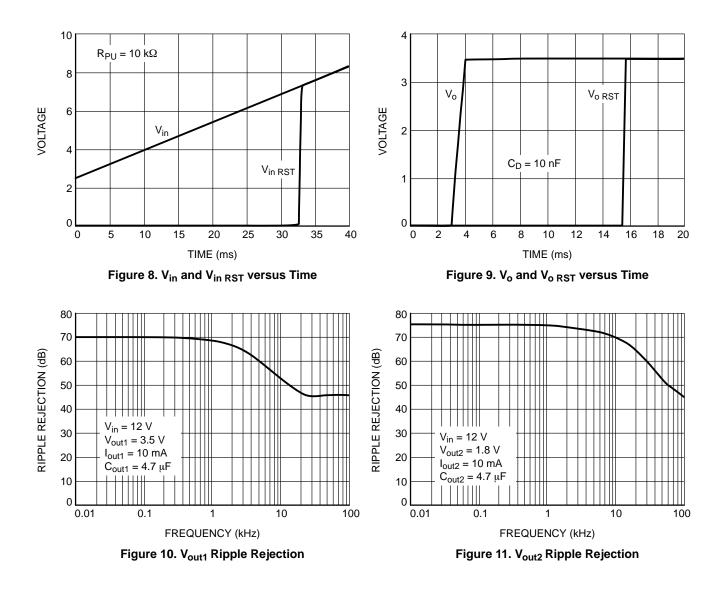
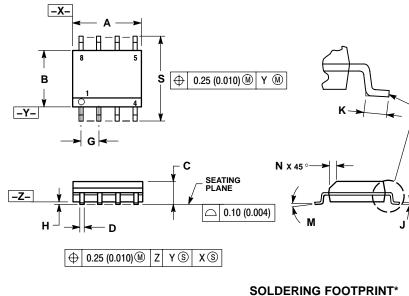


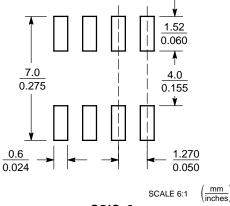
Figure 7. Delay Time versus Capacitance



PACKAGE DIMENSIONS







SOIC-8

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION. 3
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) 4. PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR 5 PROTRUSION ALLOWABLE DAMBAR PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751–01 THRU 751–06 ARE OBSOLETE. NEW STANDARD IS 751–07. 6

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27 BSC		0.050 BSC		
н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
к	0.40	1.27	0.016	0.050	
м	0 °	8 °	0 °	8 °	
Ν	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	